Single Schmitt trigger buffer Rev. 14 — 14 January 2022

1. General description

The 74LVC1G17 is a single buffer Schmitt-trigger. Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environments. This device is fully specified for partial power down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

2. Features and benefits

- Wide supply voltage range from 1.65 V to 5.5 V
- Overvoltage tolerant inputs to 5.5 V
- High noise immunity
- CMOS low power dissipation
- IOFF circuitry provides partial Power-down mode operation
- ±24 mA output drive (V_{CC} = 3.0 V)
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Unlimited rise and fall times
- Complies with JEDEC standard:
 - JESD8-7 (1.65 V to 1.95 V)
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8C (2.7 V to 3.6 V)
 - JESD36 (4.5 V to 5.5 V)
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 Class 2 exceeds 2000 V
 - MM: JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C.

3. Ordering information

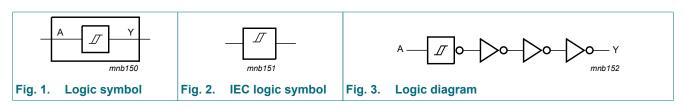
Type number	Package							
	Temperature range	Name	Description	Version				
74LVC1G17GW	-40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	; SOT353-1				
74LVC1G17GV	-40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	SOT753				
74LVC1G17GM	-40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1.45 × 0.5 mm	SOT886				
74LVC1G17GN	-40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 0.9 × 1.0 × 0.35 mm	SOT1115				
74LVC1G17GS	-40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 1.0 × 1.0 × 0.35 mm	SOT1202				
74LVC1G17GX	-40 °C to +125 °C	X2SON5	plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body 0.8 × 0.8 × 0.32 mm	SOT1226-3				
74LVC1G17GX4	-40 °C to +125 °C	X2SON4	plastic thermal enhanced extremely thin small outline package; no leads; 4 terminals; body 0.6 × 0.6 × 0.32 mm	SOT1269-2				

4. Marking

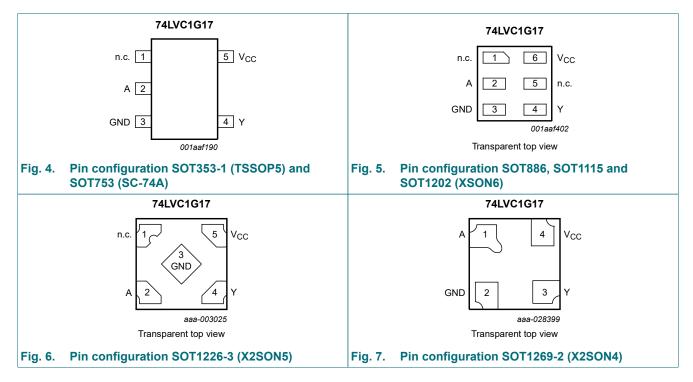
Table 2. Marking codes				
Type number	Marking[1]			
74LVC1G17GW	VJ			
74LVC1G17GV	V17			
74LVC1G17GM	VJ			
74LVC1G17GN	VJ			
74LVC1G17GS	VJ			
74LVC1G17GX	VJ			
74LVC1G17GX4	VJ			

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram



6. Pinning information



6.1. Pinning

6.2. Pin description

Symbol	Pin			Description	
	TSSOP5, SC-74A and X2SON5	XSON6	X2SON4		
n.c.	1	1, 5	-	not connected	
A	2	2	1	data input	
GND	3	3	2	ground (0 V)	
Y	4	4	3	data output	
V _{CC}	5	6	4	supply voltage	

7. Functional description

Table 4. Function table

H = HIGH voltage level; L = LOW voltage level

Input	Output
Α	Y
L	L
Н	Н

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V		-50	-	mA
VI	input voltage		[1]	-0.5	+6.5	V
I _{OK}	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V		-	±50	mA
Vo	output voltage	Active mode	[1]	-0.5	V _{CC} + 0.5	V
		Power-down mode; $V_{CC} = 0 V$	[1]	-0.5	+6.5	V
I _O	output current	$V_{O} = 0 V$ to V_{CC}		-	±50	mA
I _{CC}	supply current			-	100	mA
I _{GND}	ground current			-100	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	T _{amb} = -40 °C to +125 °C				
		TSSOP5, SC-74A, XSON6 and X2SON5 package	[2]	-	250	mW
		X2SON4 package	[3]	-	150	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SOT353-1 (TSSOP5) package: P_{tot} derates linearly with 3.3 mW/K above 74 °C.

For SOT753 (SC-74A) package: P_{tot} derates linearly with 3.8 mW/K above 85 °C.

For SOT886 (XSON6) package: P_{tot} derates linearly with 3.3 mW/K above 74 °C.

For SOT1115 (XSON6) package: Ptot derates linearly with 3.2 mW/K above 71 °C.

For SOT1202 (XSON6) package: P_{tot} derates linearly with 3.3 mW/K above 74 °C.

For SOT1226-3 (X2SON5) package: P_{tot} derates linearly with 3.0 mW/K above 67 °C.

[3] For SOT1269-2 (X2SON4) package: Ptot derates linearly with 1.7 mW/K above 57 °C.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	ymbol Parameter Conditions		Min	Тур	Мах	Unit		
V _{CC}	supply voltage		1.65	-	5.5	V		
VI	input voltage		0	-	5.5	V		
Vo	output voltage	Active mode	0	-	V _{CC}	V		
		Power-down mode; V _{CC} = 0 V	0	-	5.5	V		
T _{amb}	ambient temperature		-40	-	+125	°C		

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
T _{amb} = -	-40 °C to +85 °C					
V _{OH}	HIGH-level output voltage	$V_{I} = V_{T+}$ or V_{T-}				
		I_{O} = -100 µA; V_{CC} = 1.65 V to 5.5 V	V _{CC} - 0.1	-	-	V
		I _O = -4 mA; V _{CC} = 1.65 V	1.2	-	-	V
		I _O = -8 mA; V _{CC} = 2.3 V	1.9	-	-	V
		I _O = -12 mA; V _{CC} = 2.7 V	2.2	-	-	V
		I _O = -24 mA; V _{CC} = 3.0 V	2.3	-	-	V
		I _O = -32 mA; V _{CC} = 4.5 V	3.8	-	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{T+} \text{ or } V_{T-}$				
		I_{O} = 100 µA; V_{CC} = 1.65 V to 5.5 V	-	-	0.1	V
		I _O = 4 mA; V _{CC} = 1.65 V	-	-	0.45	V
		I _O = 8 mA; V _{CC} = 2.3 V	-	-	0.3	V
		I _O = 12 mA; V _{CC} = 2.7 V	-	-	0.4	V
		I _O = 24 mA; V _{CC} = 3.0 V	-	-	0.55	V
		I _O = 32 mA; V _{CC} = 4.5 V	-	-	0.55	V
l	input leakage current	V_{I} = 5.5 V or GND; V_{CC} = 0 V to 5.5 V	-	±0.1	±1	μA
I _{OFF}	power-off leakage current	$V_{I} \text{ or } V_{O} = 5.5 \text{ V}; V_{CC} = 0 \text{ V}$	-	±0.1	±2	μA
I _{CC}	supply current	V _I = 5.5 V or GND; V _{CC} = 1.65 V to 5.5 V; I _O = 0 A	-	0.1	4	μA
ΔI _{CC}	additional supply current	per pin; V _I = V _{CC} - 0.6 V; I _O = 0 A; V _{CC} = 2.3 V to 5.5 V	-	5	500	μA
CI	input capacitance		-	5	-	pF
T _{amb} = -	-40 °C to +125 °C					
V _{OH}	HIGH-level output voltage	$V_{I} = V_{T+}$ or V_{T-}				
		I_{O} = -100 µA; V_{CC} = 1.65 V to 5.5 V	V _{CC} - 0.1	-	-	V
		I _O = -4 mA; V _{CC} = 1.65 V	0.95	-	-	V
		I _O = -8 mA; V _{CC} = 2.3 V	1.7	-	-	V
		I _O = -12 mA; V _{CC} = 2.7 V	1.9	-	-	V
		I _O = -24 mA; V _{CC} = 3.0 V	2.0	-	-	V
		I _O = -32 mA; V _{CC} = 4.5 V	3.4	-	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{T+}$ or V_{T-}				
		I_{O} = 100 µA; V_{CC} = 1.65 V to 5.5 V	-	-	0.1	V
		I _O = 4 mA; V _{CC} = 1.65 V	-	-	0.7	V
		I _O = 8 mA; V _{CC} = 2.3 V	-	-	0.45	V
		I _O = 12 mA; V _{CC} = 2.7 V	-	-	0.6	V
		I _O = 24 mA; V _{CC} = 3.0 V	-	-	0.80	V
		I _O = 32 mA; V _{CC} = 4.5 V	-	-	0.80	V

Single Schmitt trigger buffer

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
I	input leakage current	V_{I} = 5.5 V or GND; V_{CC} = 0 V to 5.5 V	-	-	±1	μA
I _{OFF}	power-off leakage current	$V_1 \text{ or } V_0 = 5.5 \text{ V}; V_{CC} = 0 \text{ V}$	-	-	±2	μA
I _{CC}	supply current	V _I = 5.5 V or GND; V _{CC} = 1.65 V to 5.5 V; I _O = 0 A	-	-	4	μA
ΔI _{CC}	additional supply current	per pin; V _I = V _{CC} - 0.6 V; I _O = 0 A; V _{CC} = 2.3 V to 5.5 V	-	-	500	μA

[1] All typical values are measured at maximum V_{CC} and T_{amb} = 25 °C.

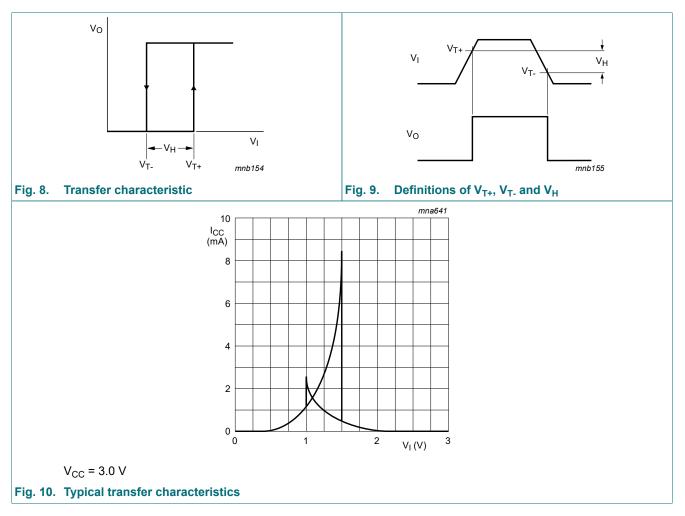
10.1. Transfer characteristics

Table 8. Transfer characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	0 °C to +85	°C	-40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
V _{T+}	positive-going	see Fig. 8 and Fig. 9						
	threshold voltage	V _{CC} = 1.8 V	0.82	1.0	1.14	0.79	1.14	V
		V _{CC} = 2.3 V	1.03	1.2	1.40	1.00	1.40	V
		V _{CC} = 3.0 V	1.29	1.5	1.71	1.26	1.71	V
		V _{CC} = 4.5 V	1.84	2.1	2.36	1.81	2.36	V
		V _{CC} = 5.5 V	2.19	2.5	2.79	2.16	2.79	V
V _{T-}	negative-going threshold voltage	see Fig. 8 and Fig. 9						
		V _{CC} = 1.8 V	0.46	0.6	0.75	0.46	0.78	V
		V _{CC} = 2.3 V	0.65	0.8	0.96	0.65	0.99	V
		V _{CC} = 3.0 V	0.88	1.0	1.24	0.88	1.27	V
		V _{CC} = 4.5 V	1.32	1.5	1.84	1.32	1.87	V
		V _{CC} = 5.5 V	1.58	1.8	2.24	1.58	2.27	V
V _H	hysteresis voltage	see <u>Fig. 8, Fig. 9</u> and <u>Fig. 10</u>						
		V _{CC} = 1.8 V	0.26	0.4	0.51	0.19	0.51	V
		V _{CC} = 2.3 V	0.28	0.4	0.57	0.22	0.57	V
		V _{CC} = 3.0 V	0.31	0.5	0.64	0.25	0.64	V
		V _{CC} = 4.5 V	0.40	0.6	0.77	0.34	0.77	V
		V _{CC} = 5.5 V	0.47	0.6	0.88	0.41	0.88	V

[1] All typical values are measured at T_{amb} = 25 °C.



10.2. Transfer characteristic waveforms

11. Dynamic characteristics

Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Fig. 12.

Symbol	Parameter	Conditions		-40 °C to +85 °C			-40 °C to +125 °C		Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _{pd}	propagation delay	A to Y; see Fig. 11	[2]						
		V _{CC} = 1.65 V to 1.95 V		1.0	4.1	11.0	1.0	14.0	ns
		V _{CC} = 2.3 V to 2.7 V		0.7	2.8	6.5	0.7	8.5	ns
		V _{CC} = 2.7 V		0.7	3.2	6.5	0.7	8.5	ns
		V _{CC} = 3.0 V to 3.6 V		0.7	3.0	5.5	0.7	7.0	ns
		V _{CC} = 4.5 V to 5.5 V		0.7	2.2	5.0	0.7	6.5	ns
C _{PD}	power dissipation capacitance	$V_I = GND \text{ to } V_{CC};$ $V_{CC} = 3.3 \text{ V}$	[3]	-	16.6	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.8 V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

[2]

 t_{pd} is the same as t_{PLH} and t_{PHL} . C_{PD} is used to determine the dynamic power dissipation (P_D in μ W). $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where: [3]

 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

 C_{L} = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching; $\sum (C_L \times V_{CC}^2 \times f_0)$ = sum of outputs.

11.1. Waveform and test circuit

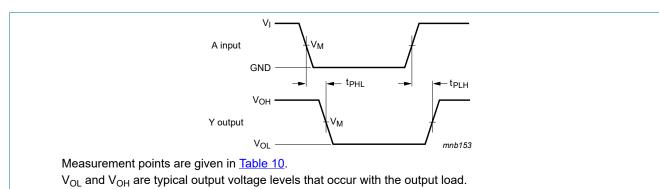
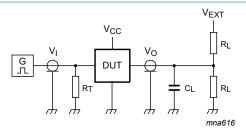


Fig. 11. The input A to output Y propagation delay times

Table 10. Measurement points

Supply voltage	Input	Output	
V _{cc}	V _M	V _M	
1.65 V to 1.95 V	0.5 x V _{CC}	0.5 x V _{CC}	
2.3 V to 2.7 V	0.5 x V _{CC}	0.5 x V _{CC}	
2.7 V	1.5 V	1.5 V	
3.0 V to 3.6 V	1.5 V	1.5 V	
4.5 V to 5.5 V	0.5 x V _{CC}	0.5 x V _{CC}	

Single Schmitt trigger buffer



Test data is given in Table 11.

Definitions for test circuit:

R_L = Load resistance.

 C_{L} = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to the output impedance Z_o of the pulse generator.

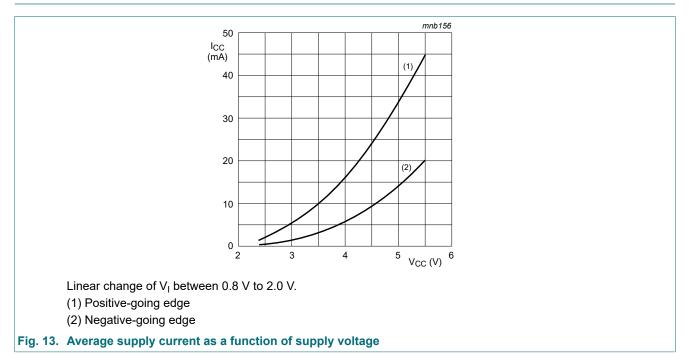
 V_{EXT} = External voltage for measuring switching times.

Fig. 12. Test circuit for measuring switching times

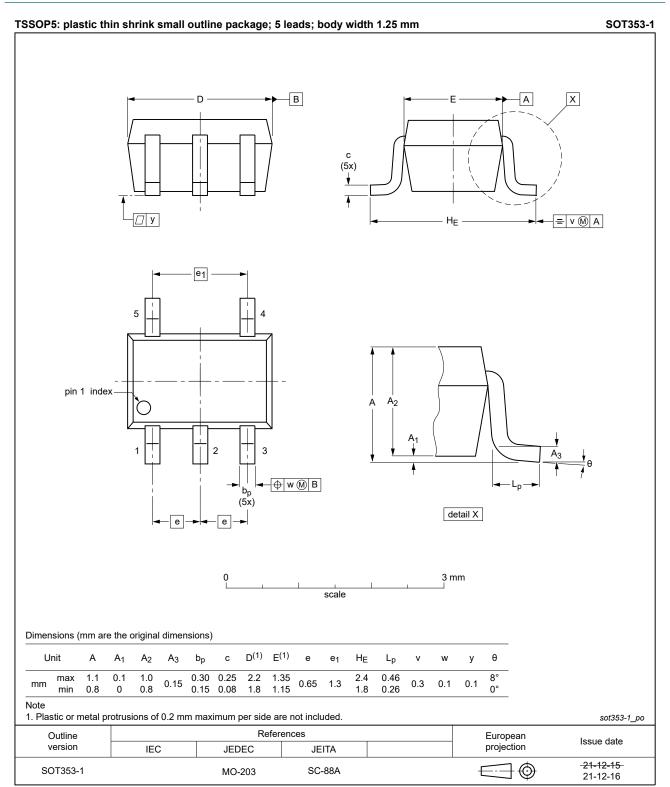
Table 11. Test data

Supply voltage	Input		Load		V _{EXT}
V _{cc}	VI	t _r = t _f	CL	RL	t _{PLH} , t _{PHL}
1.65 V to 1.95 V	V _{CC}	≤ 2.0 ns	30 pF	1 kΩ	open
2.3 V to 2.7 V	V _{CC}	≤ 2.0 ns	30 pF	500 Ω	open
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open
4.5 V to 5.5 V	V _{CC}	≤ 2.5 ns	50 pF	500 Ω	open

12. Application information



13. Package outline

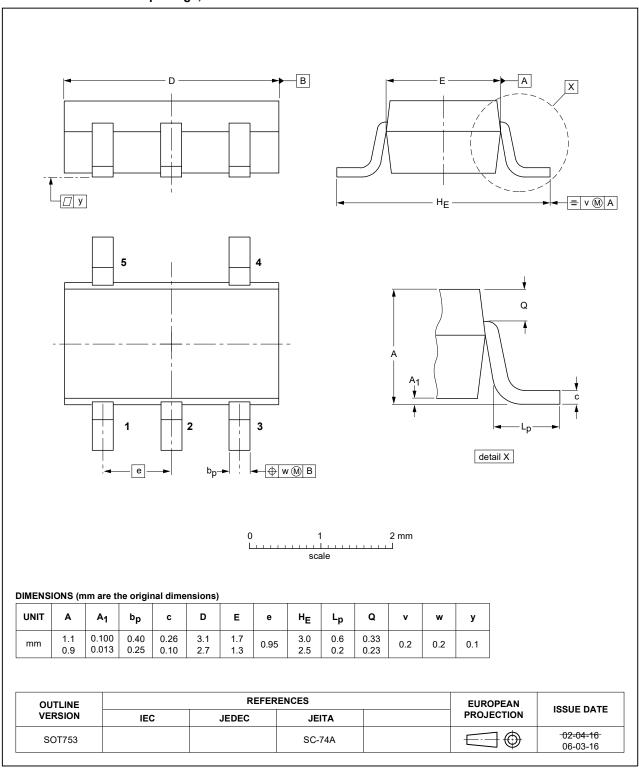




74LVC1G17 Single Schmitt trigger buffer

Plastic surface-mounted package; 5 leads

SOT753





Single Schmitt trigger buffer

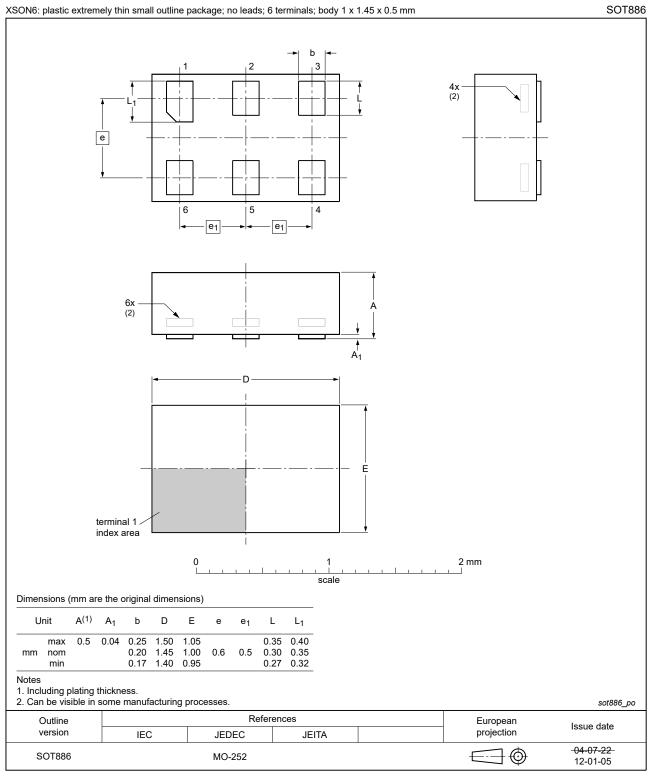
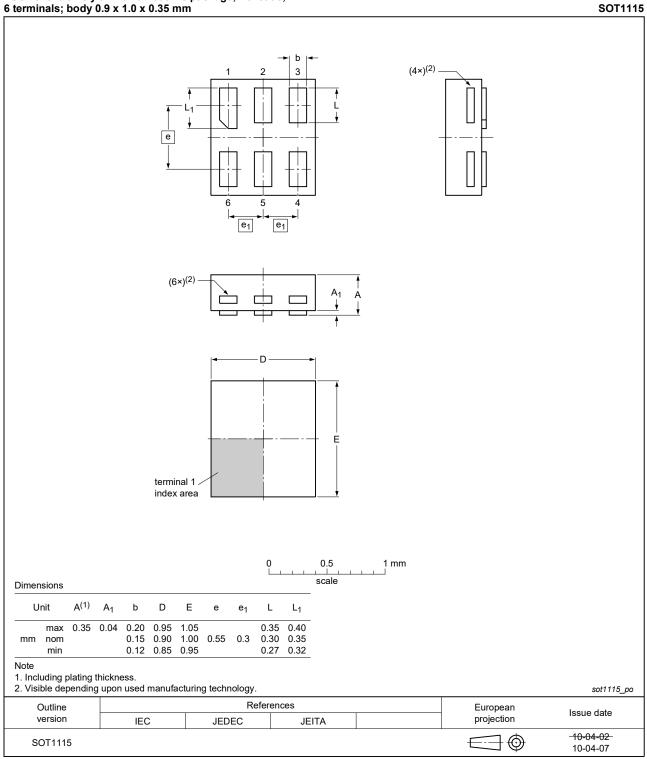


Fig. 16. Package outline SOT886 (XSON6)

74LVC1G17

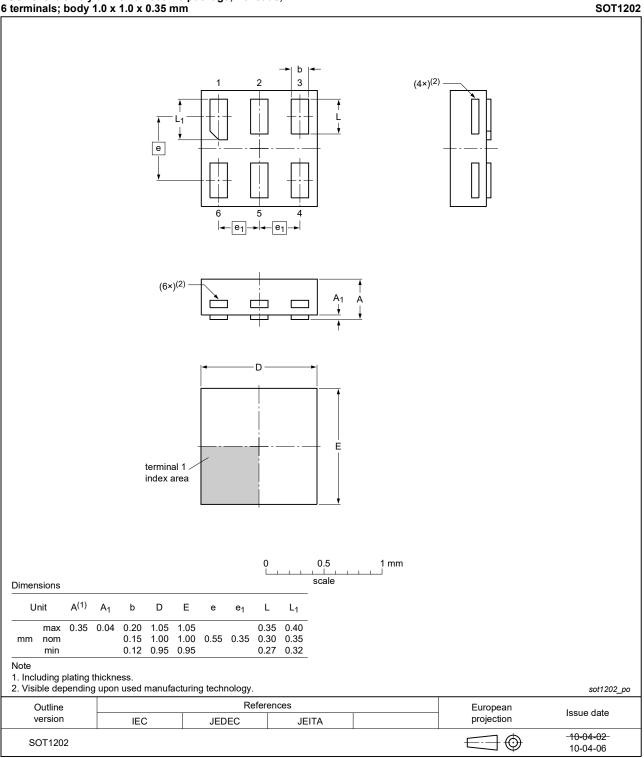
XSON6: extremely thin small outline package; no leads; 6 terminals; body 0.9 x 1.0 x 0.35 mm





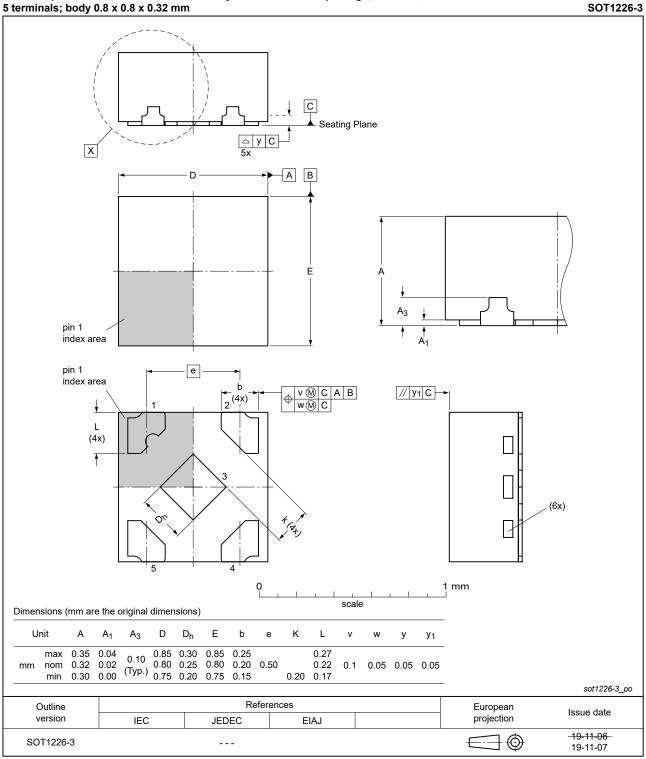
74LVC1G17

XSON6: extremely thin small outline package; no leads; 6 terminals; body 1.0 x 1.0 x 0.35 mm





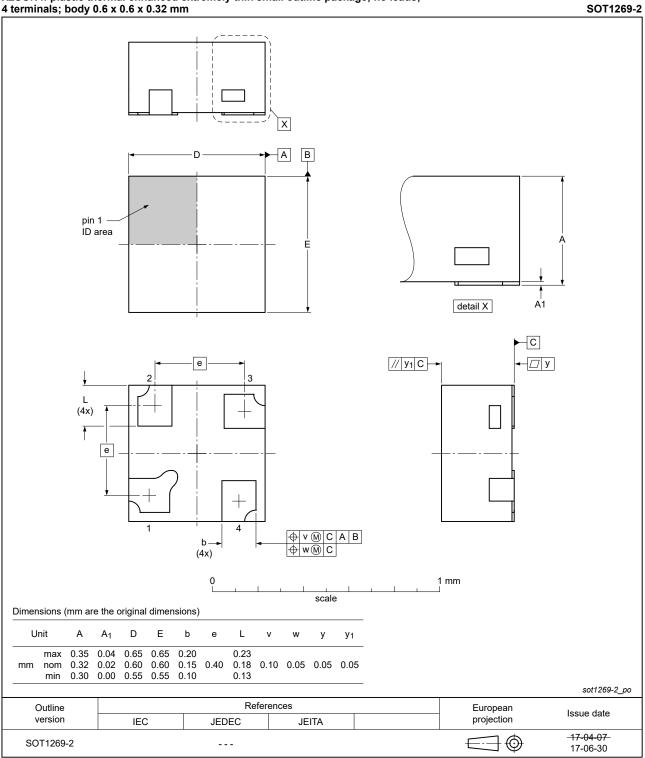
74LVC1G17



X2SON5: plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body 0.8 x 0.8 x 0.32 mm



Single Schmitt trigger buffer



X2SON4: plastic thermal enhanced extremely thin small outline package; no leads; 4 terminals; body 0.6 x 0.6 x 0.32 mm

Fig. 20. Package outline SOT1269-2 (X2SON4)

14. Abbreviations

Table 12. Abbreviations				
Acronym	Description			
CMOS	Complementary Metal Oxide Semiconductor			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
MM	Machine Model			
TTL	Transistor-Transistor Logic			

15. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC1G17 v.14	20220114	Product data sheet	-	74LVC1G17 v.13	
Modifications:	• Fig. 14: Package outline drawing for SOT353-1 (TSSOP5) has changed.				
74LVC1G17 v.13	20210504	Product data sheet	-	74LVC1G17 v.12	
Modifications:	 <u>Section 1</u> and <u>Section 2</u> updated. SOT1226 (X2SON5) package changed to SOT1226-3 (X2SON5) package. Type number 74LVC1G17GF (SOT891/XSON6) removed. <u>Table 5</u>: Derating values for P_{tot} total power dissipation updated. 				
74LVC1G17 v.12	20180608	Product data sheet	-	74LVC1G17 v.11	
Modifications:	 The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Added type number 74LVC1G17GX4 (SOT1269-2) 				
74LVC1G17 v.11	20161202	Product data sheet	-	74LVC1G17 v.10	
Modifications:	• <u>Table 7</u> : The maximum limits for leakage current and supply current have changed.				
74LVC1G17 v.10	20120629	Product data sheet	-	74LVC1G17 v.9	
Modifications:	 Added type number 74LVC1G17GX (SOT1226) Package outline drawing of SOT886 (Fig. 16) modified. 				
74LVC1G17 v.9	20111206	Product data sheet	-	74LVC1G17 v.8	
Modifications:	Legal pages updated.				
74LVC1G17 v.8	20110920	Product data sheet	-	74LVC1G17 v.7	
74LVC1G17 v.7	20101110	Product data sheet	-	74LVC1G17 v.6	
74LVC1G17 v.6	20070827	Product data sheet	-	74LVC1G17 v.5	
74LVC1G17 v.5	20061006	Product data sheet	-	74LVC1G17 v.4	
74LVC1G17 v.4	20041130	Product specification	-	74LVC1G17 v.3	
74LVC1G17 v.3	20041018	Product specification	-	74LVC1G17 v.2	
74LVC1G17 v.2	20040407	Product specification	-	74LVC1G17 v.1	
74LVC1G17 v.1	20040324	Product specification	-	-	

Single Schmitt trigger buffer

16. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <u>https://www.nexperia.com</u>.

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Contents

1. General description	1
2. Features and benefits	1
3. Ordering information	2
4. Marking	
5. Functional diagram	2
6. Pinning information	
6.1. Pinning	
6.2. Pin description	
7. Functional description	
8. Limiting values	
9. Recommended operating conditions	
10. Static characteristics	
10.1. Transfer characteristics	6
10.2. Transfer characteristic waveforms	7
11. Dynamic characteristics	8
11.1. Waveform and test circuit	
12. Application information	9
13. Package outline	
14. Abbreviations	
15. Revision history	17
16. Legal information	
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